

WINSTAR Display

OLED SPECIFICATION

Model No:

WEO001602HLPP3N00000

SPECIFICATION

Version: C

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CU	10	U	VIC	=R	- 1

MODULE NO.: WEO001602HLPP3N00000

APPROVED BY:

(FOR CUSTOMER USE ONLY)

SALES BY	APPROVED BY CHECKE	D BY PREPARED BY
		No P
RELEASE DATE:		

APPROVAL FOR SPECIFICATIONS ONLY

APPROVAL FOR SPECIFICATIONS AND SAMPLE

MODEL NO:

REC	ORDS OF REV	ISION	DOC. FIRST ISSUE
VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2021/10/07		First release
Α	2022/10/04		Modify Reliability Test and measurement conditions
В	2023/04/27		Modify Lifetime note
С	2023/05/18		Modify the inspection criteria name of the inspection specification

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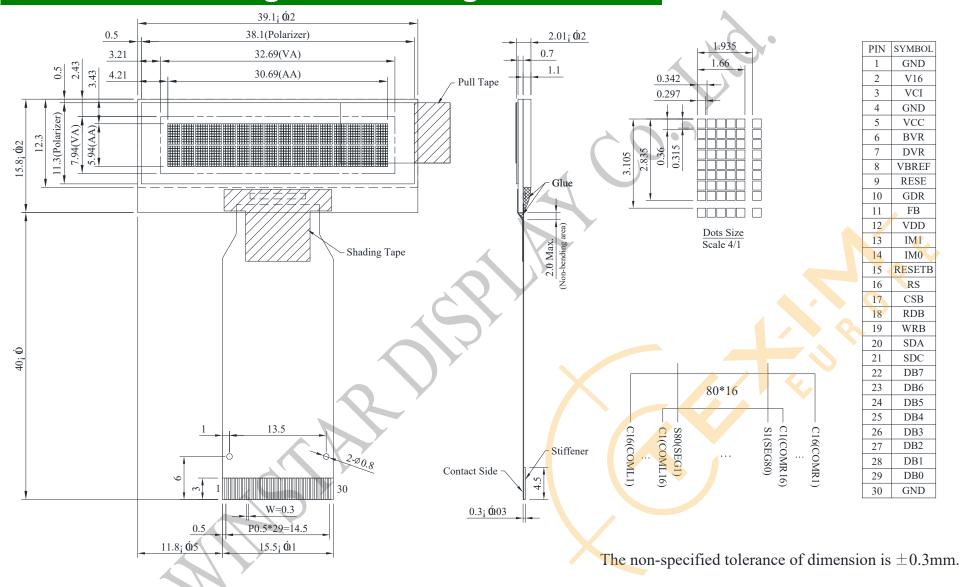
1.Module Classification Information

1	Brand : WINST	AR DISPLAY CORPORA	ATION	
2	E: OLED			A .
		H: COB Character	G : COB Graphic	
	D: 1 T	O: COG	F: COG + FR	4
3	Display Type	P: COG + FR + PCB	X : COF	
		A: COG + PCB	N: COF + FR + PCB	
4	Dot Matrix: 16	6 * 02		
5	Serials code			
		A : Amber	R: Red	C : Full Color
6	Emitting Color	B: Blue	W : White	
0	Emilling Color	G: Green	L: Yellow	
		S : Sky Blue	X : Dual Color	
7	Polarizer	P: With Polarizer; N: V		
-		A : Anti-glare Polarizer		
8	Display Mode			
9	Driver Voltage	3:3.0~3.3V; 5:5		
10	Touch Panel	N : Without touch pane	ei; i: vvith touch panei	
		0 : Standard		
		1 : Daylight Readable	(-22)	
11	Product type	2 : Transparent OLED	` ,	
		3 : Flexible OLED (FO	LED)	
		4 : OLED Lighting		4
		0 : Standard		
12	Inspection	2 : Special grade		
	Grade	C : Automotive grade		
	N	Y : Consumer grade		
13	Option	·	Kit ; E~P : Op <mark>t</mark> ions ; Z :	Semi-customized
14	Serial No.	Serial numbe <mark>r</mark> (00~99)		

2.General Specification

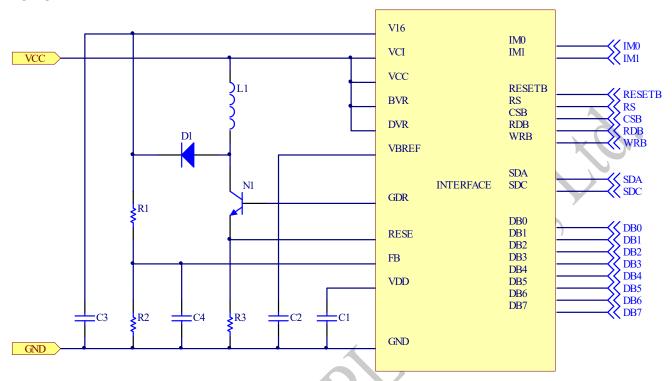
Item	Dimension	Unit
Number of Characters	16 characters x 2 Lines	_
Module dimension	39.1 x 15.8 x 2.01	mm
View area	32.69 x 7.94	mm
Active area	30.69 x 5.94	mm
Dot size	0.297 x 0.315	mm
Dot pitch	0.342 x 0.36	mm
Character size	1.66 x 2.835	mm
Character pitch	1.935 x 3.105	mm
Panel type	OLED , Yellow	
Duty	1/16	
IC	WS0012	
Interface	6800, 8080, SPI, I2C	
Size	1.23 inch	

3. Contour Drawing & Block Diagram



3.1 Application recommendations

DCDC Solution



Recommended components:

C1, C2: 1.0uF

C3: 4.7uF

C4: 10nF

 $\mathsf{R1}:\mathsf{1M}\Omega$

 $R2:170K\Omega$

 $\mathsf{R3}:\mathsf{1}\Omega$

D1: LL4148

L1: 10uH

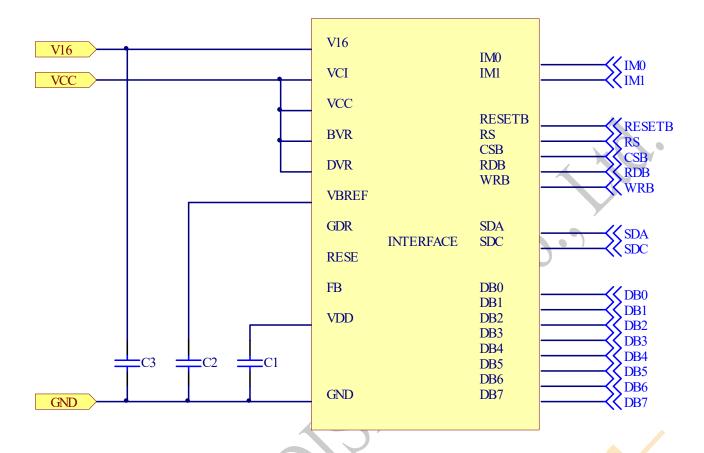
N1: MOSFET

Bus Interface selection: 6800, 8080, SPI, I2C

Note:

(1). The component value is recommended value. Select appropriate value against module application.

External V16 Solution



Recommended components:

C1, C2: 1.0uF

C3: 4.7uF

Bus Interface selection: 6800, 8080, SPI, I2C

Note:

(1). The capacitor value is recommended value. Select appropriate value against module application.

4. Interface Pin Function

Pin No.	Symbol	Level	Description
1	GND	Р	Ground Pin
2	V16	I	This is the most positive voltage supply pin of the chip. It can be supplied externally or generated internally by using internal DC-DC voltage converter.
3	VCI	Р	DCDC buffer Power Supply
4	GND	Р	Ground Pin
5	VCC	Р	Power Pin
6	BVR	I	Brightness control pin. It should be connected to VCC.
7	DVR	I	Pre charge time control. It should be connected to VCC.
8	VBREF	0	This pin is the internal voltage reference of DCDC1 circuit. A stabilization capacitor should be connected between this pin and GND
9	RESE	I	NMOS source input pin: This pin connects to the source current pin of the external NMOS of the booster circuit.
10	GDR	0	Gate drive pulse output pin: This output pin drives the gate of external NMOS of the booster circuit.
11	FB	ı	Feedback voltage input pin: This pin is the feedback resistor input of the booster circuit. It is used to adjust the booster output voltage level.
12	VDD	Р	Power Pin (connect to stabilization capacitor)
13	IM1		Interface selection IM1 IM0 Interface L 6800-series
14	IMO	? .	L H 8080-series H L SPI H H I2C
15	RESETB	I	Reset pin
16	RS	I	Register Select Input Pin When this pin is set to "0", it is used as an Instruction Register. When this pin is set to "1", it is used for as the Data Register.
17	CSB	I	Chip select input pins Data / instruction I/O is enabled only when CSB is "L".

	<u> </u>				
			Read / Write ex	ecution o	control pin
			MPU Type	RDB	Description
18	RDB	I	6800-series	E	Read / Write control input pin - RW = "H": When E is "H", DB0 to DB7 are in an output status RW = "L": The data on DB0 to DB7 are latched at the falling edge the E signal.
			8080-series	RDB	Read enable clock input pin When / RDB is "L", DB0 to DB7 are in an output status.
			Read / Write ex	ecution o	control pin
			MPU Type	WRB	Description
19	WRB	I	6800-series	RW	Read / Write control input pin - RW = "H" : read - RW = "L" : write
			8080-series	WRB	Write enable clock input pin. The data on DB0 to DB7 are latched at the rising edge of the /WRB signal.
				1	
20	SDA	I/O	SDA is the seri	al data i	nput for I2C.
21	SDC	I/O	SDC is the seri	al clock	input/output for I2C.
22~25	DB7~DB4	I/O	the MPU and V When SPI is se DB7 will be the	used for VS0012. elected, l serial d	or data transfer and reception between DB5 will be the serial clock input: SCL
26~29	DB3~DB0	1/0	the MPU and V	used fo VS0012.	or data transfer <mark>and reception</mark> between
30	GND	P	Ground Pin		

5.Absolute Maximum Ratings

Item	Symbol	Min	Max	Unit	Notes
Operating Temperature	TOP	-40	+80	°C	
Storage Temperature	TST	-40	+85	°C	
Supply Voltage For Logic	vcc	-0.3	3.6	V	1, 2
Supply Voltage For DCDC	VCI	-0.3	3.6	V	1, 2
Supply Voltage for Display	V16	-0.3	19.0	V	1, 2

NOTES:

- 1. VCC, VCI and V16 are based on GND = 0V
- 2. If supply voltage exceeds its absolute maximum range, this LSI may be damaged permanently. It is desirable to use this LSI under electrical characteristic conditions during general operation. Otherwise, this LSI may malfunction or reduced LSI reliability may result.



6.Electrical Characteristics

6.1 DC Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	VCC	_	2.6	3.3	3.5	V
Supply Voltage For DCDC converter	VCI	_	2.6	3.3	3.5	V
Supply Voltage for Display	V16	_	_	8.5	9.0	V
Input High Volt.	VIH	_	0.9xVCC	0	vcc	V
Input Low Volt.	VIL	_	GND		0.1xVCC	V
Output High Volt.	VOH	IOH=-0.5mA	0.8xVCC	_	VCC	V
Output Low Volt.	VOL	IOL=0.5mA	GND	_	0.2xVCC	V
50% Check Board Operating Current	I16	V16=8.5V	_	2	4	mA

Notes: The V16 value can be adjusted according to the demand brightness. When V16 is lowered, the brightness decreases or when V16 is increased, the brightness increases. The V16 value is set within the recommended range. The life time of OLED is directly related to the set brightness, and lower brightness helps to improve the life time.

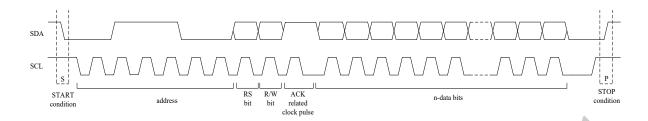
6.2 Initial code

```
void Initial_WS0012(){
    DelayX1ms(500);
                           // Wait 500ms for power stabilization
    Write Ins(0x38);
                           //function set
    Write Ins(0x38);
                           //function set
    Write Ins(0x38);
                           //function set
    Write Ins(0x13);
                           // C/G MODE / Sleep
                           //Entry Table 2
    Write Ins(0x03);
    Write Ins(0x76);
                           //Smart Pre-charge
    Write Ins(0x2C);
                           //Power control: External V16
                           //Power control: DCDC converter
    // Write Ins(0x2D);
    Write Ins(0x6B);
                           //BVR
    Write Ins(0x73);
                           //DVR
    Write Ins(0x30);
                           //Starting line
    Write Ins(0x00);
                           //Exit Table 2
    Write Ins(0x01);
                           //Clear Display
                           //Once executing the "Clear Display" command,
    DelayX1ms(2);
                           //the minimum wait time is 1.5ms.
                           //Return Home
    Write Ins(0x02);
                           //Display direction
    Write Ins(0x16);
    Write Ins(0x06);
                           //Entry Mode Set
    Write Ins(0x0F);
                           //Display control
    Write_Ins(0x0C);
    Write Ins(0x00);
```

Note 1: Initial code is for reference only. Please make the best adjustment with the OLED module. Note 2: Command: BVR BRIGHTNESS INSTRUCTION, this instruction sets the BVR resistor for the brightness adjustment. The chip has 16 BVR steps from 60h to 6Fh. The BVR step value decreases, the OLED brightness increases.

}

I2C-bus data format



(a)I2C address

The slave address is following the start condition for recognition use. The slave address is "b011100"

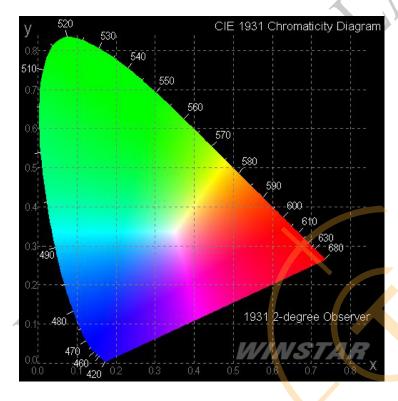
- (b) "RW" bit is used to determine the operation mode of the I2C-bus interface. RW =1, it is in read mode. RW =0, it is in write mode.
- (c) The RS bit determines the next data byte is acted as a command or a data. If the RS bit is set to logic "0", it defines the following data byte as a command. If the RS bit is set to logic "1", it defines the following data byte as a data which will be stored at the GDDRAM.



7.Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Viou Anglo	(V)θ	_	160		_	deg
View Angle	(H)φ	_	160	_	-	deg
Contrast Ratio	CR	Dark	10,000:1	_	X	~-
Deepenso Time	T rise	_	_	10		μs
Response Time	T fall	_	_	10	_	μs
Display with 100%	% check Board E	Brightness ⁽¹⁾	100	120	_	cd/m2
CIEx(Yello	w)	(CIE1931)	0.45	0.47	0.49	_
CIEy(Yello	w)	(CIE1931)	0.48	0.50	0.52	_

Note1: The brightness value is based on the setting of V16 equal to the Typical value.



8.OLED Lifetime

ITEM	Conditions	Min	Тур	Remark
Operating Life Time	Ta=25°C / Initial 50% checkerboard brightness 100cd/m²	50,000 Hrs	-	Note

Note:

- 1. Lifetime is defined the amount of time when the luminance has decayed to <50% of the minimal brightness.
- 2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
- 3. Screen saving mode will extend OLED lifetime.
- 4. Lifetime is not guaranteed one but expected lifetime in normal condition.



9. Reliability

Content of Reliability Test

Environmenta	l Test		
Test Item	Content of Test	Test Condition	Applicable Standard
High Temperature storage	Endurance test applying the high storage temperature for a long time.	85°C 240hrs	- 3
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-40°C 240hrs	-17
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80°C 240hrs	0.,
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40°C 240hrs)
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60°C,90%RH 240hrs	
High Temperature/ Humidity Operation	Endurance test applying the high temperature and high humidity Operation for a long time.	60°C,90%RH 120hrs	
Temperature Cycle	Endurance test applying the low and high temperature cycle. -40°C 25°C 80°C 30min 5min 30min 1 cycle	-40°C /80°C 30 cycles	
Mechanical Te	st		
Vibration test	Endurance test applying the vibration during transportation and using.	Frequency:10~55Hz amplitude:1.5mm Time:0.5hrs/axis Test axis:X,Y,Z	40
Others			
Static electricity test	Endurance test applying the electric stress to the finished product housing.	Air Discharge model ±4kv,10 times	

^{***} Supply voltage for OLED system =Operating voltage at 25°C

Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the functional test at 23±5°C; 55±15% RH.
- 2. All-pixels on/off exchange is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle.
- 4. No Condensation.

Evaluation criteria

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within ± 50% of initial value.

APPENDIX:

RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.



10.Inspection specification

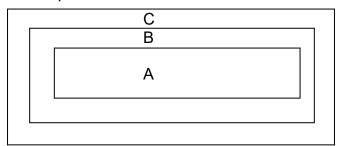
Inspection Standard:

MIL-STD-105E table normal inspection single sample level II.

Definition

- 1 Major defect: The defect that greatly affect the usability of product.
- 2 Minor defect : The other defects, such as cosmetic defects, etc.

Definition of inspection zone:



Zone A: Active Area

Zone B: Viewing Area except Zone A

Zone C: Outside Viewing Area

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble of quality and assembly to customer's product.

Inspection Methods

- 1 The general inspection: Under fluorescent light illumination: 750~1500 Lux, about 30cm viewing distance, within 45° viewing angle, under 25±5°C.
- 2 The luminance and color coordinate inspection : By SR-3 or BM-7 or the equal equipments, in the dark room, under 25±5°C.

NO	Item	Criterion		
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 OLED viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 		
02	Black or white spots on OLED (display only)	 2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm. 		

NO	Item	Criterion				AQL
03	OLED black spots, white spots, contamination (non-display)	3.1 Round type : As following drawing Φ=(x+y)/2 →X	SIZE	Acceptable QTY ignore 2 1	Zone A+ B A+ B A+ B A+ B	2.5
		3.2 Line type : (As	following drawing)	Acceptable Q TY		
		 L≦3.0 L≦2.5		ignore	A+B A+B	
04	Polarizer bubbles /Dent	4.1 If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction. 4.2 The polarizer of	Size Φ $\Phi \leq 0.20$ $0.20 < \Phi \leq 0.50$ $0.50 < \Phi \leq 1.00$ $1.00 < \Phi$ $Total Q TY$ dent follows this specific	Acceptable Q TY ignore 3 2 0 3 ecification.	Zone A+B A+B A+B A+B	2.5
05	Scratches	Follow NO.3 OLED black spots, white spots, contamination.				

NO	Item	Criterion	AQL
06	Chipped	Symbols Define: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: OLED side length L: Electrode pad length: 6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:	2.5
06	Glass crack		2.5

NO	Item	6.2.2 Non-conductive portion: y: Chip width x: Chip length z: Chip thickness $y \le L$ $x \le 1/8a$ $0 < z \le t$ Olf the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. Olf the product will be heat sealed by the customer, the alignment mark not be damaged.		
06	Glass crack	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	2.5	
07	Cracked glass	The OLED with extensive crack is not acceptable.		
08	Backlight elements	3.1 Illumination source flickers when lit. 3.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards. 3.3 Backlight doesn't light or color wrong. 3.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.		
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints,	0.65 2.5 0.65	
10	PCB, COB	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down. 	2.5 2.5 0.65 2.5 2.5 0.65 2.5	



NO	Item	Criterion	AQL
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65
12	General appearance	 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 OLED pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet. 	2.5 0.65 2.5 2.5 2.5 2.5 0.65 0.65 0.65

Check Item	Classification	Criteria	
No Display	Major		
Missing Line	Major		
Pixel Short	Major		
Dark Pixel	Major		
Wrong Display	Major		
Un-uniform B/A x 100% < 70% A/C x 100% < 70%	Major	A Normal B Dark Pixel C Light Pixel	

11.Precautions in use of OLED Modules

Modules

- (1) Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, change the components or modify its shape of OLED display module.
- (3) Don't disassemble the OLED display module.
- (4) Do not apply input signals while the logic power is off.
- (5) Don't operate it above the absolute maximum rating.
- (6) Don't drop, bend or twist OLED display module.
- (7) Soldering: only to the I/O terminals.
- (8) Hot-Bar FPC soldering condition: 280~350C, less than 5 seconds.
- (9) Winstar has the right to change the passive components (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.) and change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) Winstar has the right to upgrade or modify the product function.
- (11) For COG & COF structure OLED products, customers should reserve VCC (VPP) adjustment function or software update function when designing OLED supporting circuit. (The progress of OLED light-emitting materials will increase the conversion efficiency and the brightness. The brightness can be adjusted if necessary).

11.1. Handling Precautions

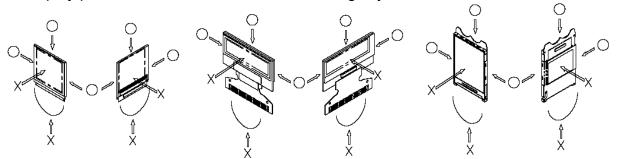
- (1) Since the display panel is being made of glass, do not apply mechanical impacts such as dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged. So, be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage by using following adhesion tape.
- * Scotch Mending Tape No. 810 or an equivalent

Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.

Also, pay attention that the following liquid and solvent may spoil the polarizer:

- * Water
- * Ketone
- * Aromatic Solvents
- (6) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.
- (7) Do not touch the following sections whenever possible while handling the OLED display modules.
- * Pins and electrodes

- * Pattern layouts such as the TCP & FPC
- (8) Hold OLED display module very carefully when placing OLED display module into the System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- (9) Do not apply stress to the LSI chips and the surrounding molded sections.
- (10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.
- * Be sure to make human body grounding when handling OLED display modules.
- * Be sure to ground tools to use or assembly such as soldering irons.
- * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
- * Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.

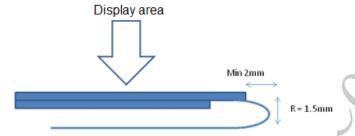
11.2. Storage Precautions

- (1) When storing OLED display modules, put them in static electricity preventive bags to avoid be directly exposed to sun or lights of fluorescent lamps. And, also, place in the temperature 25±5°C and Humidity below 65% RH.(We recommend you to store these modules in the packaged state when they were shipped from Winstar. At that time, be careful not to let water drops adhere to the packages or bags.)
- (2) When the OLED display module is being dewed or when it is placed under high temperature or high humidity environments, the electrodes may be corroded if electric current is applied. Please store it in clean environment.

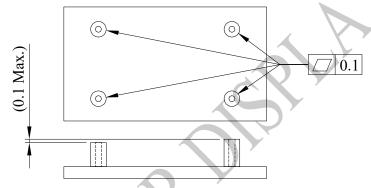
11.3. Designing Precautions

- (1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, OLED display module may be damaged.
- (2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specification and to make the signal line cable as short as possible.
- (3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD / VCC). (Recommend value: 0.5A)
- (4) Pay sufficient attention to avoid occurrence of mutual noise interference with the nearby devices.
- (5) As for EMI, take necessary measures on the equipment side basically.
- (6) If the power supplied to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.
- * Connection (contact) to any other potential than the above may lead to rupture of the IC.
- (7) If this OLED driver is exposed to light, malfunctioning may occur and semiconductor

- elements may change their characteristics.
- (8) The internal status may be changed, if excessive external noise enters into the module. Therefore, it is necessary to take appropriate measures to suppress noise generation or to protect module from influences of noise on the system design.
- (9) We recommend you to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.
- (10) It's pretty common to use "Screen Saver" to extend the lifetime and Don't use the same image for long time in real application. When an OLED display module is operated for a long of time with fixed pattern, an afterimage or slight contrast deviation may occur.
- (11) The limitation of FPC and Film bending.



(12) The module should be fixed balanced into the housing, or the module may be twisted.



(13) Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

11.4. Precautions when disposing of the OLED display modules

(1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.



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Please contact us if you have any questions about the contents of the datasheet.

This may not be the latest version of the datasheet. Please check with us if a later version is available.



Texim Europe - contact details



Headquarters & Warehouse

Elektrostraat 17 NL-7483 PG Haaksbergen The Netherlands

T: +31 (0)53 573 33 33 E: info@texim-europe.com Homepage: www.texim-europe.com







The Netherlands

Elektrostraat 17 NL-7483 PG Haaksbergen

T: +31 (0)53 573 33 33 E: nl@texim-europe.com



Belgium

Zuiderlaan 14, box 10 B-1731 Zellik

T: +32 (0)2 462 01 00 E: belgium@texim-europe.com



UK & Ireland

St Mary's House, Church Lane Carlton Le Moorland Lincoln LN5 9HS

T: +44 (0)1522 789 555 E: uk@texim-europe.com



Germany

Bahnhofstrasse 92 D-25451 Quickborn

T: +49 (0)4106 627 07-0 E: germany@texim-europe.com



Germany

Martin-Kollar-Strasse 9 D-81829 München

T: +49 (0)89 436 086-0 E: muenchen@texim-europe.com



Austria

Warwitzstrasse 9 A-5020 Salzburg

T: +43 (0)662 216 026 E: austria@texim-europe.com



Nordic

Stockholmsgade 45 2100 Copenhagen

T: +45 88 20 26 30 E: nordic@texim-europe.com



Italy

Martin-Kollar-Strasse 9 D-81829 München

T: +49 (0)89 436 086-0 E: italy@texim-europe.com